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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

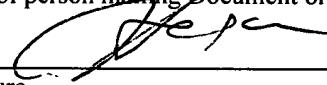
Assistant Commissioner of Patents
BOX Non-Fee Amendment
Washington, D.C. 20231



I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to:
Assistant Commissioner of Patents,
Washington, D.C. 20231 on February 18, 2003
(Date of Deposit)

Harold C. Moore

Name of person mailing Document or Fee


Signature

February 18, 2003

Date of Signature

Re: Application of: Newell E. Chiesl
Serial No.: 09/960,441
Filed: September 21, 2001
For: Arrangement for Measuring Pressure on a
Semiconductor Wafer and an Associated
Method for Fabricating a Semiconductor
Wafer
Group Art Unit: 2812
Examiner: Viktor Simkovic
Our Docket No.: 1003-0610

TRANSMITTAL OF RESPONSE TO OFFICE ACTION

Please find for filing in connection with the above patent application the following:

1. Response to Office Action.

* The fee has been calculated as shown below.

CLAIMS AS AMENDED				
	Claims Remaining After Amendment	Highest No. Paid For	Fee Calculation	Addit Fee
Total Claims	11	20	0 X 9	\$ 0.00
Independent Claims	2	3	0 X 42	\$ 0.00
Total Additional Fee Required				\$ 0.00

Please charge any fee deficiency, or credit any overpayment, to Deposit Account No. 13-0014; but not to include any payment of issue fees.

Respectfully Submitted,

MAGINOT, MOORE & BOWMAN



February 18, 2003

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Enclosures